

AMENDMENTS TO THE SPECIFICATION:

Amend the paragraph beginning on page 7 at line 12 as follows:

In multi-layer food packaging applications, a barrier resin bonds to a substrate which can be rigid or flexible. Coextrusion of the adhesive tie layer, barrier resin, and substrate bonds the dissimilar resins during processing. Polybutene improves the tack and adhesion of the tie layer and can reduce formulation costs. Food packaging applications using a hot melt extrudable adhesive include cups, trays, plates, bags and lid films. Most Indopol grades have food contact approval. For compliance status of specific Indopol and Panalene grades, phone [[. . .]] (deleted, not relevant).